

Dual Band 2-Way SMT Power Divider

2800~4200MHz WCDMA, LTE & 5G

Device Features

- Typical Isolation = 25.0 dB @ 3.5GHz
- Typical Insertion Loss = 0.6 dB @ 3.5GHz
- MSL 3 moisture rating
- Small Size and Low Profile
- RoHS2-compliant SOT-26 Plastic Package



BD35XX(XX=Wafer number)

Product Description

BeRex's Divider BD3526 is designed for WCDMA, LTE band and 5G with low Insertion Loss and Isolation. This chip is fully passivated for enhanced performance and reliability and packaged in RoHS2-compliant with SOT-26 surface mount package.

Typical Performance¹

Parameter	Min	Typical	Max	Unit
Frequency Range	2800		4200	MHz
Insertion Loss		0.6	0.8	dB
Isolation	16	25		dB
IRL(S11)		-25	-16	dB
ORL(S22/S33)		-25	-15	dB
Amplitude Balance		0.08	0.15	dB
Phase Balance		0.4	3.0	deg

*All specifications apply to the following test conditions,

1. Device performance _ measured on BeRex E/B at 25°C, 50ohm system.

2. Insertion Loss: Above 3.0dB.

Applications

- Base station Infrastructure
- Commercial/Industrial/Military wireless system
- 5G/LTE/WCDMA Wireless Infrastructure

Evaluation Board Drawing



*RO4003C_0.4T

Absolute Maximum Ratings

Parameter	Rating
Input Power	1.5W CW dBm
Storage Temperature	-55 to +155°C
Operating Temperature	-40 to +105°C

Operation of this device above any of these parameters may result in permanent damage.

Function Block Diagram



Pins 2,4 and 6 must be DC and RF grounded.

•website: <u>www.berex.com</u>

•email: sales@berex.com



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Typical lest Data						
Parameters	Unit	WCDMA, LTE & 5G				
Frequency Range	MHz	2800	3200	3500	3800	4200
Insertion Loss	dB	0.62	0.63	0.59	0.63	0.82
Isolation	dB	15.7	23.7	38.0	22.4	16.5
IRL(S11)	dB	-17.0	-20.3	-26.1	-33.3	-16.8
ORL(S22,S33)	dB	-15.7	-20.1	-27.3	-33.3	-20.6
Phase Diff.	deg	0.39	0.33	0.38	0.60	0.54
Amplitude Balance	dB	0.10	0.08	0.05	0.05	0.08

Typical Test Data









ORL vs. Frequency



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	MILLIMETERS			
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	6		
Pitch	е	0.95 BSC		
Outside Lead Pitch	e1	1.90 BSC		
Overall Height	A	0.90	-	1.45
Molded Package Thickness	A2	0.89	-	1.30
Standoff	A1	0.00		0.15
Overall Width	E	2.20	-	3.20
Molded Package Width	E1	1.30	-	1.80
Overall Length	D	2.70	-	3.10
Foot Length	L	0.10	-	0.60
Footprint	L1	0.35	-	0.80
Foot Angle	¢	0°	_	30°
Lead Thickness	С	0.08	-	0.26
Lead Width	b	0.20	-	0.51

Suggested PCB Land Pattern and PAD Layout





Note : All dimension _ millimeters

BeRex

PCB lay out _ on BeRex website

•website: <u>www.berex.com</u>

PCB Mounting



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Package Marking



Tape & Reel



Packaging information:

Tape Width (mm): 8 Reel Size (inches): 7 Device Cavity Pitch (mm): 4 Devices Per Reel: 2000

Lead plating finish

100% Tin Matte finish

(All BeRex products undergoes a 1 hour, 150 degree C, Anneal bake to eliminate thin whisker growth concerns.)



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MSL / ESD Rating

MSL Rating: Level 3 at +260°C convection reflow

Standard: J

JEDEC Standard J-STD-020



Proper ESD procedures should be followed when handling this device.

RoHS Compliance

This part is compliant with Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) Directive 2011/65/EU as amended by Directive 2015/863/EU. This product also is compliant with a concentration of the Substances of Very High Concern (SVHC) candidate list which are contained in a quantity of less than 0.1%(w/w) in each components of a product and/or its packaging placed on the European Community market by the BeRex and Suppliers.

NATO CAGE code:

